

Docket No.: MIY-0212
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Koichi Shibayama et al.

Application No.: 10/581,928

Confirmation No.: 1990

Filed: June 7, 2006

Art Unit: 1796

For: THERMOSETTING RESIN COMPOSITION,
RESIN SHEET AND RESIN SHEET FOR
INSULATED SUBSTRATE

Examiner: Michael J. Feely

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the non-final Office Action dated May 20, 2009, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.